

Attorney's Docket No. LAM1P077

As a below-named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

is attached hereto

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: SEMICONDUCTOR PROCESS CHAMBER ELECTRODE AND METHOD FOR MAKING THE SAME, the specification of which,

(check one)	۲۰ ا	13 attached no.	1010.	
	2. 🗀	was filed on		as
	ــــ	_	ion Serial No.	
		• •	nded on	
	3. 🔲			as
	_	International:	PCT Application Serial No.	
		and was amer	nded on	·
I hereby state that amended by any a			and the contents of the above	ve-identified specification, including the claims, as
I acknowledge the 37, CFR § 1.56.	e duty to disclos	se information v	which is material to the exan	nination of this application in accordance with Title
than the United S	States, listed be ate, or PCT In	low and have	identified below, by checki	lication which designated at least one country other ng the box, any foreign application for patent or before that of the application on which priority is Priority Benefits Claimed?
				YesNo
(Appl. No.)		(Country)	(Filing Date)	
				YesNo
(Appl. No.)		(Country)	(Filing Date)	•
				Yes No
<u></u>	· · · · · · · · · · · · · · · · · · ·	(Country)	(Filing Date)	
(Appl. No.)		(Country)	(Filling Date)	
I hereby claim the	e benefit under 3	35 U.S.C. §119(e) of any United States provi	sional application(s) listed below:
(Application Seria	al No.)	(Filing Date)		
(Application Serie	al No.)	(Filing Date)		

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s), or § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of Title 35, United States Code, § 112, I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application:

Residence:

Post Office Address:

(City) Santa Clara

3480 Tracy Drive, Santa Clara, CA 95051

Prior U.S. Applicati n(s)		·			
(Application Serial No.)		(Filing Date)	(Status - patented, pending, ab	andoned)	
(Application Serial No.)		(Filing Date)	(Status - patented, pending, ab	andoned)	
Penilla (Reg. No. 39,487)	; Brian R. Colem Kim (Reg. No. 39,	an (Reg. No. 39,145); P 462); and Jerray Wei (ncluding Paul L. Hickman (Re eter B. Martine (Reg. No. 32,04 Reg. No. 43,247) as my principa Office connected therewith:	3); Dawn L. Palmer (Reg.	
Send Correspondence To:		Albert S. Penilla HICKMAN & MARTINE, LLP P.O. BOX 52037 Palo Alto, California 94306			
Direct Telephone Calls T	o:	Albert S. Penilla at telephone number (650) 470-7430			
belief are believed to be tra like so made are punishab	ue; and further that le by fine or impri	t these statements were n sonment, or both, under	lge are true and that all statemen nade with the knowledge that wil section 1001 of Title 18 of the U ation or any patent issuing therec	lful false statements and the Jnited States Code, and that	
Typewritten Full Name of Sole or First Inventor: Inventor's signature:	Andras Kuthi	_'/<	Citizenship: Date of Signature:	USA 6/18/98	
Residence: (City)	Thousand Oaks		(State/Country)	CA	
Post Office Address:	717 Pamela Wood	l Street, Thousand Oaks,	CA 91320		
Full Name of Second Joint Inventor (if any):	t Lumin Ji	<u>/</u> >	Citizenship:	China	
Inventor's signature:	Firmin	太.	Date of Signature:_	6/18198	

(State/Country)

CA